DEPARTMENT OF ELECTRICAL ENGINEERING
I. I. T. KANPUR
Printed Circuit Board Fabrication Facility
Job Order for Making PCB

Job Order No. : _______________________                                           Date   _________________
Name of Indentor: _______________________________                       Tel. No. ______________
Name of the Department   :  ________________________
Designation /Roll No. : ____________________________
Project No. if any   :  _________________________________________
Description of Circuit: _______________________________________
Size of PCB/Mask: __________________________           No. of PCB/Mask: _____________

Job Requirements (Tick the items needed):
Photographic           :  Camera /Contact Print               Photo plotting (GBR files)       
                        :  CNC Drilling                                CNC Milling/Chemical Etch.    
Microwave PCB     :  Without Gold plating                  Nickel Gold Plating           
Solder Masking      :   Top Layer                Bottom Layer  
Legend Printing      :   Top Layer                          Bottom Layer  
Copper Clad Sheet:   S.S.Paper Phenolic                    D.S.Epoxy Non -PTH            
                        :   S.S.Epoxy                                  D.S.Epoxy PTH  

PCB Design File Name:                     Multi-layer PCBs:
PCB File   :     __________________________               Four layers  
DDB File  :       Six layers                        
Laser Printout File      :    ___________________________   Eight layers  

Signature of Indentor                                                        Signature of the Proj. Co-ordinator/
Investigator/Course Co-ordinator/                                                Head of the department.
Head EE/ACES

Incharge PCB Facility.           Faculty Co- ordinator               Head EE/ACES
PCB Fabrication Facility  (For external & Chargeable Job)
Checked and received the above PCB from the Printed Circuits Board Fabrication Facility.

Signature of the Receiver.

Date: ________________

For Sponsored Project /Research/Lab Development/Course.

Total Cost –Rs. ________________

The amount of Rs. ____________________________________________________________

may be transferred from Project No./Department ________________________________

______________________________ to Project No.  IIT / PEE / 9262.

Head of the Department  Project Investigator

This is to declare that the PCB being ordered will / will not be used for a Sponsored Project.

Signature of Indentor (Faculty Supervisor for Student Indentors)